

EV Group introduces NanoCleave layer release technology - September 14, 2022



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Plunge in memory market to drop Samsung to second place; Intel expected to fall to third. [More>>](#)

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Secretaries of State, Commerce discuss efforts to build a U.S. microelectronics ecosystem

U.S. Secretary of State Antony J. Blinken and Secretary of Commerce Gina Raimondo visited Purdue University on Tuesday (Sept. 13) to tour university research facilities and meet students as they embark on their mission to bolster the U.S. semiconductor industry. [More>>](#)

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With the further development of the Metaverse, smart wearable devices such as VR headsets will have an increasing demand for high-bandwidth memory. [More>>](#)



EV Group introduces NanoCleave layer release technology

IR laser cleave technology enables nanometer-precision layer transfer through silicon, eliminating glass substrates for advanced packaging and enabling thin-layer 3D stacking. [More>>](#)



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Business News

Aehr receives wafer-level burn-in system order from new major supplier of silicon carbide semiconductors

Aehr Test Systems announced it has received a purchase order from a new customer for a FOX-NP multi-wafer test and burn-in system, multiple WaferPak Contactors and a FOX WaferPak Aligner to be used for qualification of Aehr's wafer level burn-in solution for silicon carbide devices for electric vehicles and other markets. [More>>](#)



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SkyWater to expand its advanced packaging facility operations in Florida

Grant is part of \$50.8M award from the Economic Development Administration's Build Back Better Regional Challenge to grow Osceola County's NeoCity as an innovation center for semiconductor research, design and manufacturing. [More>>](#)



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